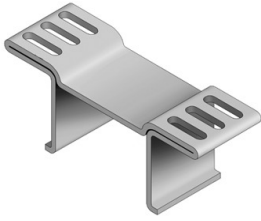


Data sheet Product FK 244 08 D2 PAK TR



Board Level heatsinks>Copper heatsinks for D PAK and others

- direct PCB mounting thru solderable surface
- available standard packing: loose parts (**bulk goods**) or reel (**TR** = tape and reel)
- **tape width:** 44 mm, **reel diameter:** 330 mm, **quantity:** FK 244 08 = 450, FK 244 13 = 200

Features

for transistor:

- SOT 223
- D³ PAK (TO 268)
- SO-14
- D² PAK (TO 263)
- Power SO 10
- D PAK (TO 252)
- SO-16
- SO-8

width:	26 mm
height:	10 mm
length:	8 mm
thermal resistance:	29.3 K/W
surface:	solderable surface
material:	copper (Cu)
material thickness:	0.6 mm

Technical Drawing

